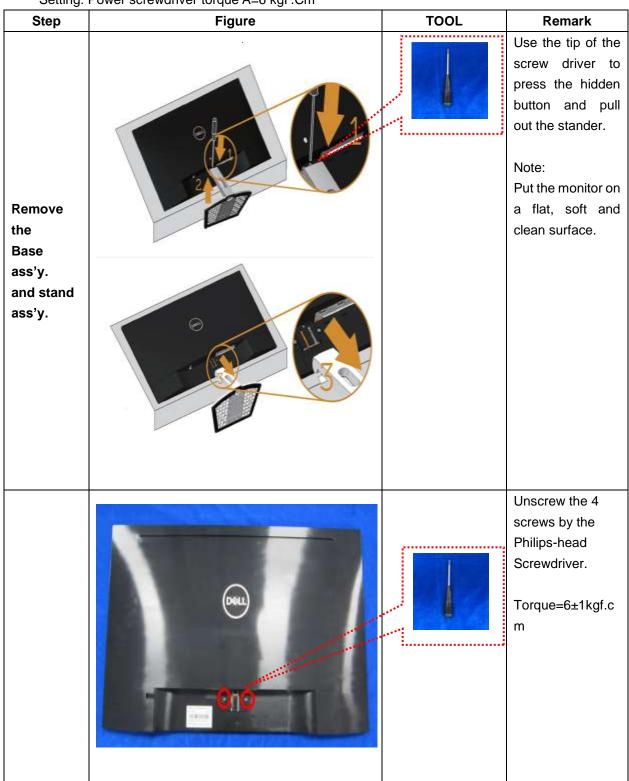
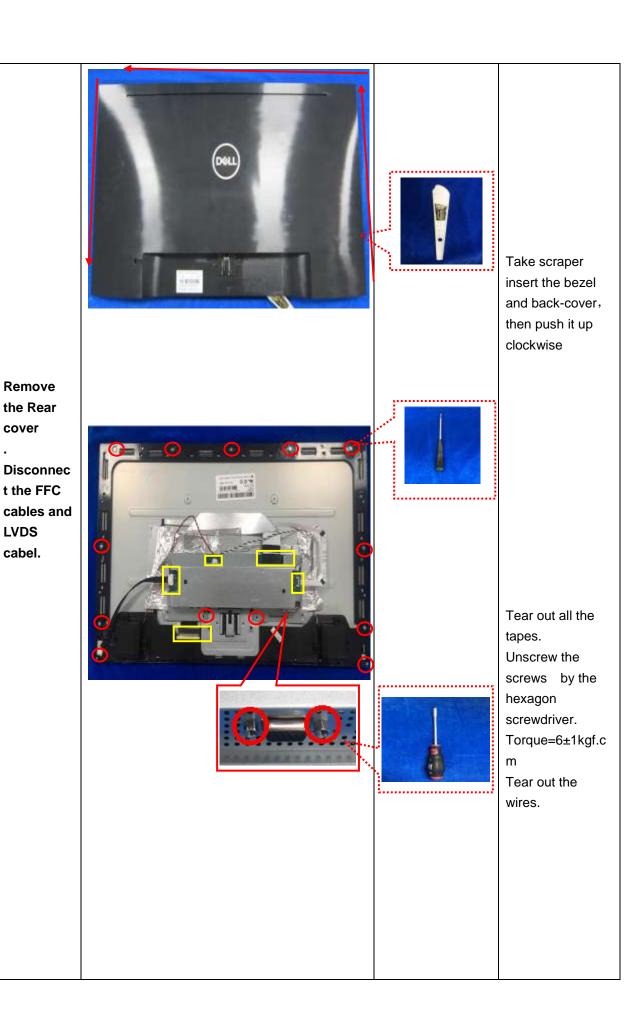
1. Mechanical Instruction

1.1Disassembly Procedures

Tools: 2 Power screwdrivers (ϕ =5mm, L=60mm); 1 small cross screwdriver; turnbuckle driver; Setting: Power screwdriver torque A=6 kgF.Cm





	Separate the key board and Middle frame and bezel.
	Turn over the middle frame, remove the screws by the Philips-head. Torque=6±1kgf.c m
Main board	
Mainframe	



1.2. Product material information

Panel

The following substances, preparations, or components should be disposed of or recovered

separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing PCB/PCT)	No used	
Mercury containing components	No used	
Batteries	No used	
Printed circuit boards (with a surface	Product has printed circuit boards (with	
greater than 10 square cm)	a surface greater than 10 square cm)	
Component contain toner, ink and liquids	No used	
Plastic containing BFR	No used	
Component and waste contain asbestos	No used	
CRT	No used	
Component contain CFC, HCFC, HFC	No used	
and HC		
Gas discharge lamps	No used	
LCD display > 100 cm2	Product has an LCD greater than 100	
	cm2	
External electric cable	Product has external cables	
Component contain refractory ceramic	No used	
fibers		
Component contain radio-active	No used	
substances		
Electrolyte capacitors (height	Product has electrolyte capacitors	
> 25mm, diameter > 25mm)	(height > 25mm, diameter > 25mm)	

1.3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point

where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver (Phillip-head, Hexagonal head)
- Penknife
- Soldering iron and absorber